



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jens Barrenschenn et al. Atty. Dkt. No.: INFJR-0004

Assignee: Infineon Technologies AG and Robert Bosch GmbH

Title: "ARRANGEMENT COMPRISING A FIRST SEMICONDUCTOR
CHIP AND A SECOND SEMICONDUCTOR CHIP CONNECTED
THERE TO"

Serial No. 10/727,108

File Date: 12/02/2003

Examiner: unknown

Art Unit: 3651

Attorney Docket No.: INFJR-0004

Date: July 1, 2004

Mail Stop Missing Parts
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Dear Sir:

Please amend the claims in the above-identified
application. No new matter is added.